EVERLIGHT ELECTRONICS CO.,LTD.

Technical Data Sheet

High Performance SMD LED with Reflector

93-21UYOC/S530-XX/TR8

Features



- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Eia std. package.
- IC compatible.
- Pb- free
- The product itself will remain within RoHS compliant version.

Applications

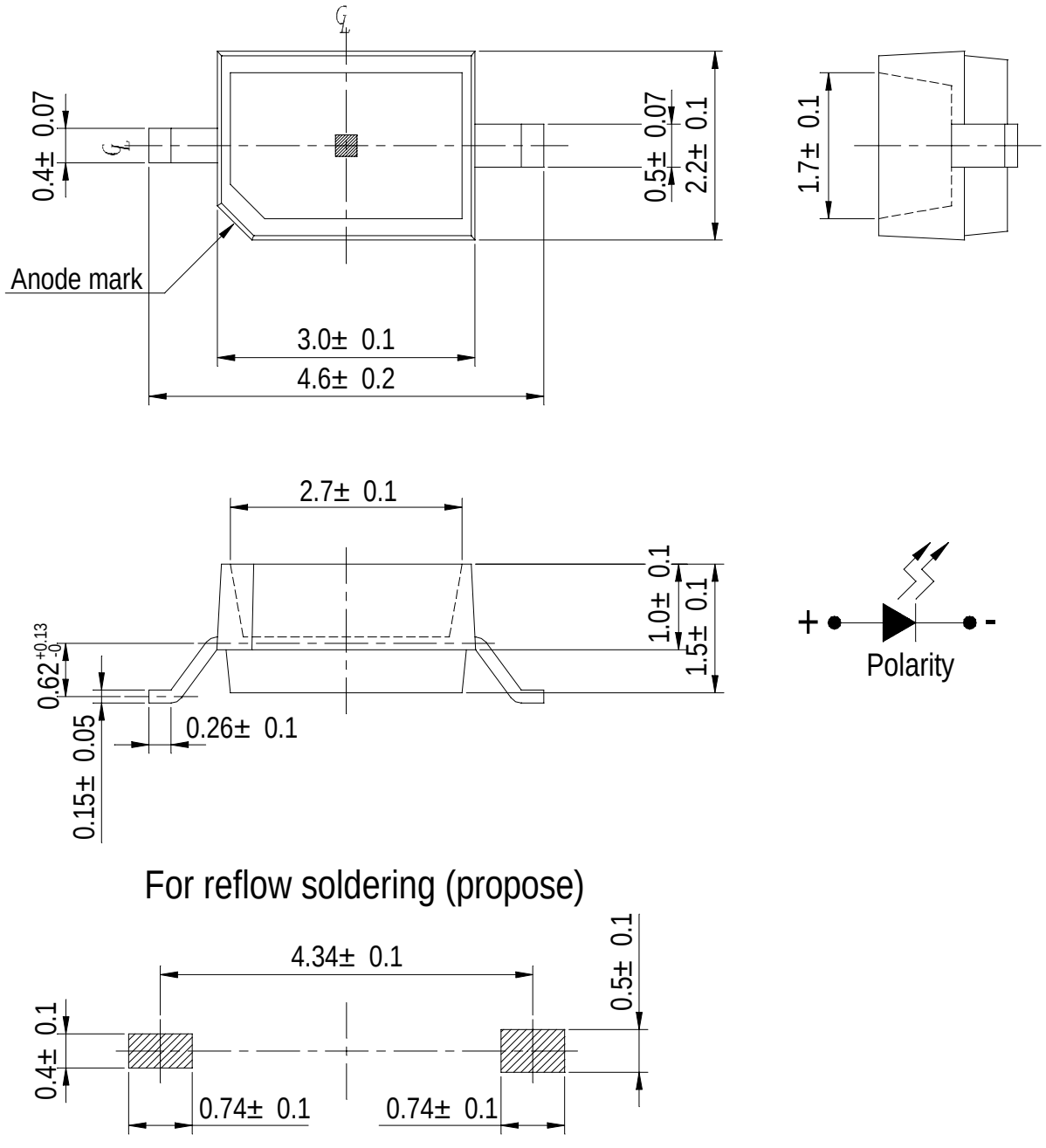
- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Indicator and backlight for audio and video equipment
- Indicator and backlight for battery driven equipment.
- Flat backlight for LCD, switch and symbol.
- Light pipe application.
- General use.

Device Selection Guide

Chip		Lens Color
Material	Emitted Color	
AlGaInP	Brilliant Orange	Water Clear

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Package Outline Dimensions



Notes: All dimensions are in millimeters.

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Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_F	25	mA
Operating Temperature	Topr	-40 ~ +85	℃
Storage Temperature	Tstg	-40 ~ +100	℃
Electrostatic Discharge(HBM)	ESD	2000	V
Power Dissipation	Pd	60	mW
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	60	mA
Soldering Temperature	Tsol	Reflow Soldering : 260 ℃ for 10 sec. Hand Soldering : 350 ℃ for 3 sec.	

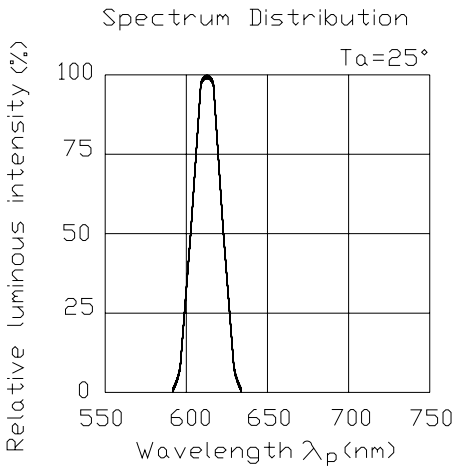
Electro-Optical Characteristics (Ta=25℃)

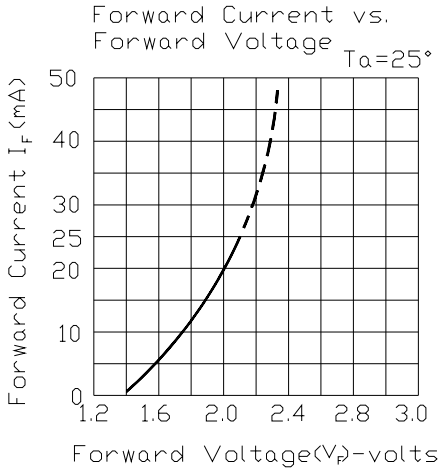
Parameter	Symbol	*Chip Rank	Min.	Typ.	Max.	Unit	Condition
Luminous intensity	I_V	A2	17	23	-----	mcd	I_F=20mA
		A3	20	60	-----		
		A4	25	75	-----		
		A5	32	95	-----		
		A6	40	120	-----		
Viewing Angle	$2\theta 1/2$	-----	-----	130	-----	deg	I_F=20mA
Peak Wavelength	λp	-----	-----	611	-----	nm	I_F=20mA
Dominant Wavelength	λd	-----	-----	605	-----	nm	I_F=20mA
Spectrum Radiation Bandwidth	$\triangle \lambda$	-----	-----	17	-----	nm	I_F=20mA
Forward Voltage	V_F	-----	-----	2.0	2.4	V	I_F=20mA
Reverse Current	I_R	-----	-----	-----	10	μA	VR=5V

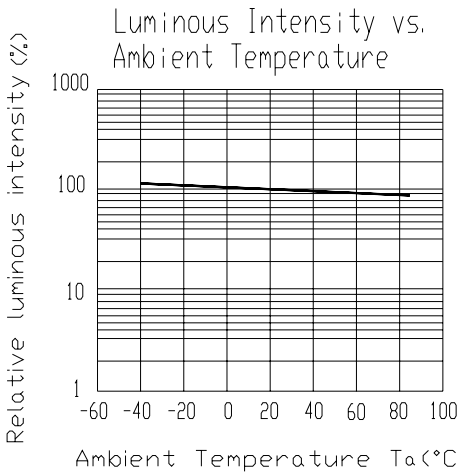
***93-21UYOC/S530-XX/TR8**

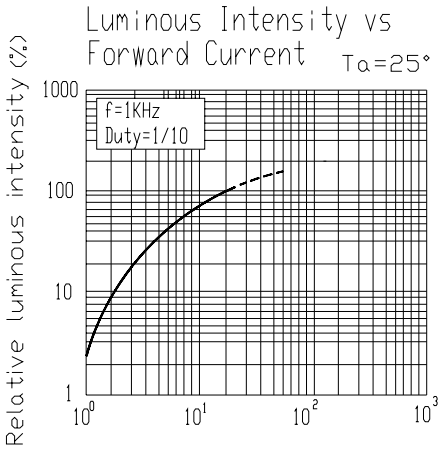
Chip Rank

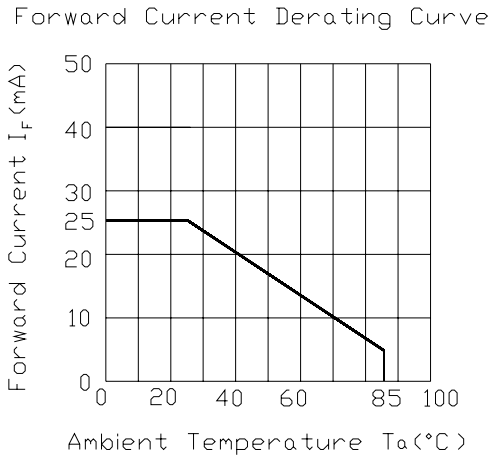
Typical Electro-Optical Characteristics Curves

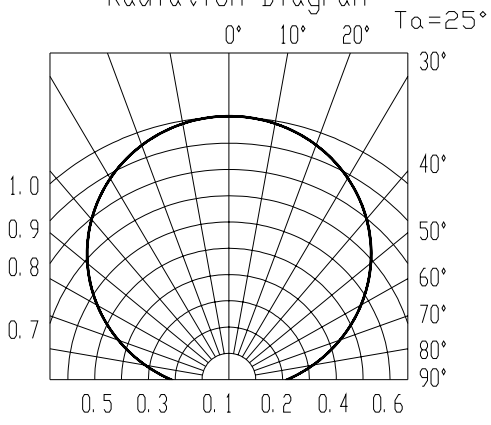










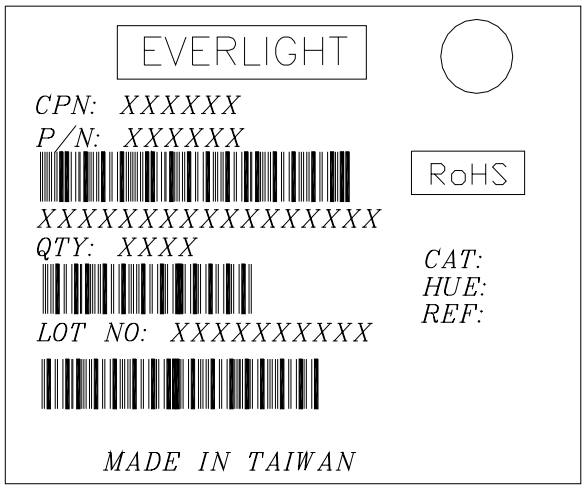


Label explanation

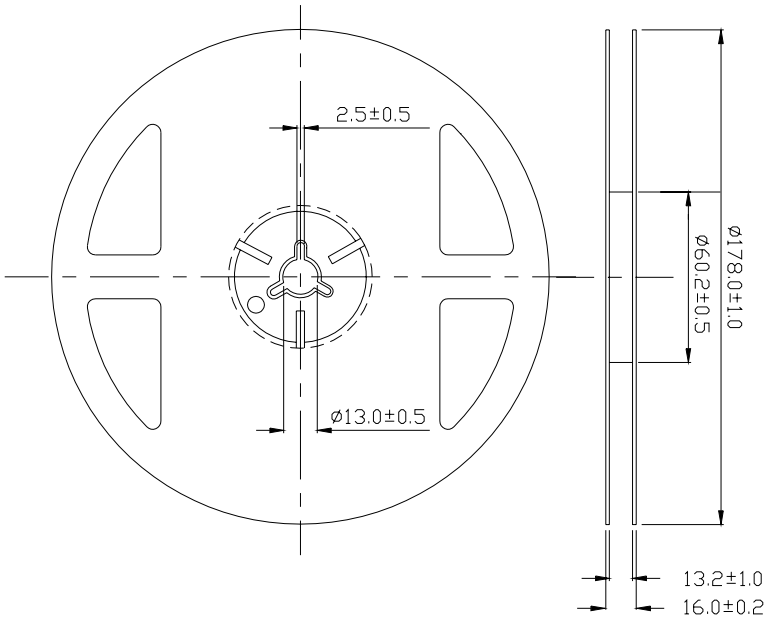
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank

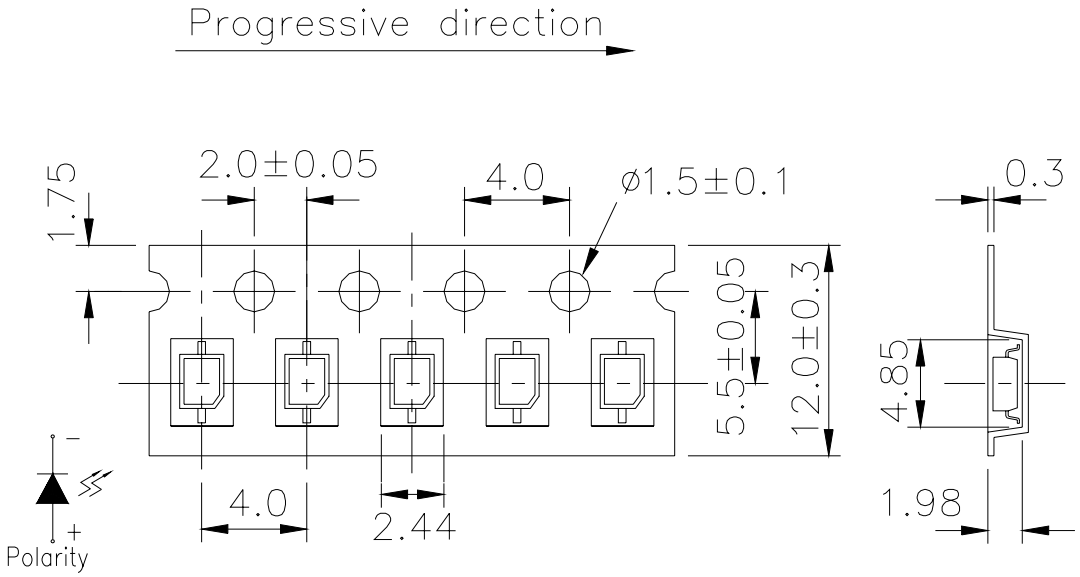


Reel Dimensions

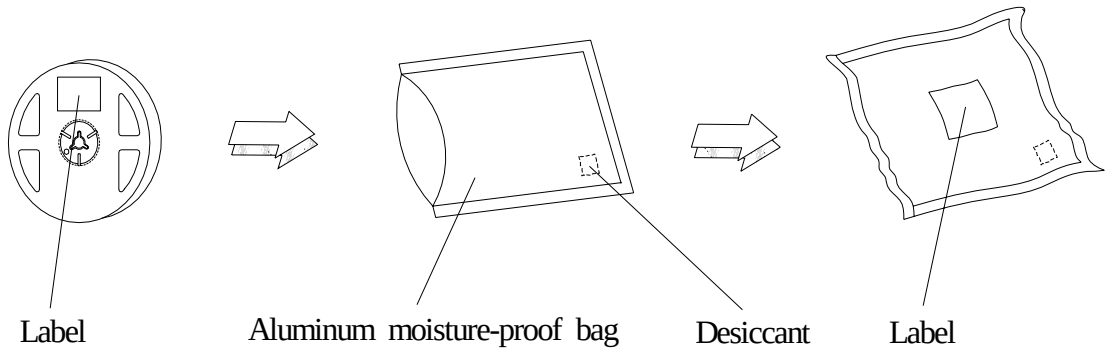


Note: The tolerances unless mentioned is ±0.1mm ,Unit = mm

Carrier Tape Dimensions: Loaded quantity per reel 2000 PCS/reel



Moisture Resistant Packaging



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.
Confidence level：90%
LTPD：10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Solder Heat	Temp. : 260℃±5℃ Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100℃ 15min ∫ 5 min L : -40℃ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100℃ 5min ∫ 10 sec L : -10℃ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	I_F = 20 mA	1000 Hrs.	22PCS.	0/1
7	High Temperature / High Humidity	85℃/ 85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1. Over-current-proof

   Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

   2.1 Do not open moisture proof bag before the products are ready to use.

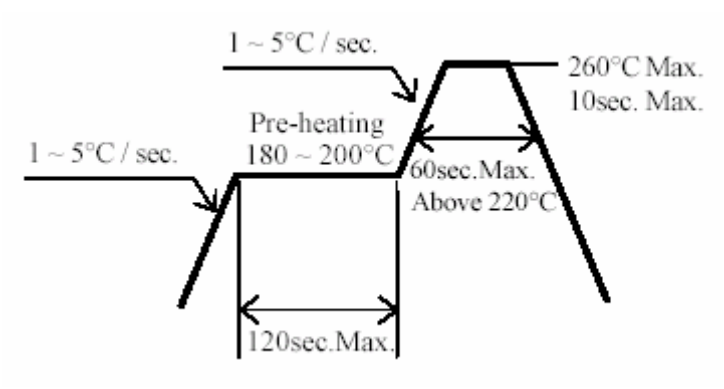
   2.2 Before opening the package, the LEDs should be kept at 30℃ or less and 90%RH or less.

   2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

   2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
   Baking treatment : 60±5℃ for 24 hours.

3. Soldering Condition

   3.1 Pb-free solder temperature profile



   3.2 Reflow soldering should not be done more than two times.

   3.3 When soldering, do not put stress on the LEDs during heating.

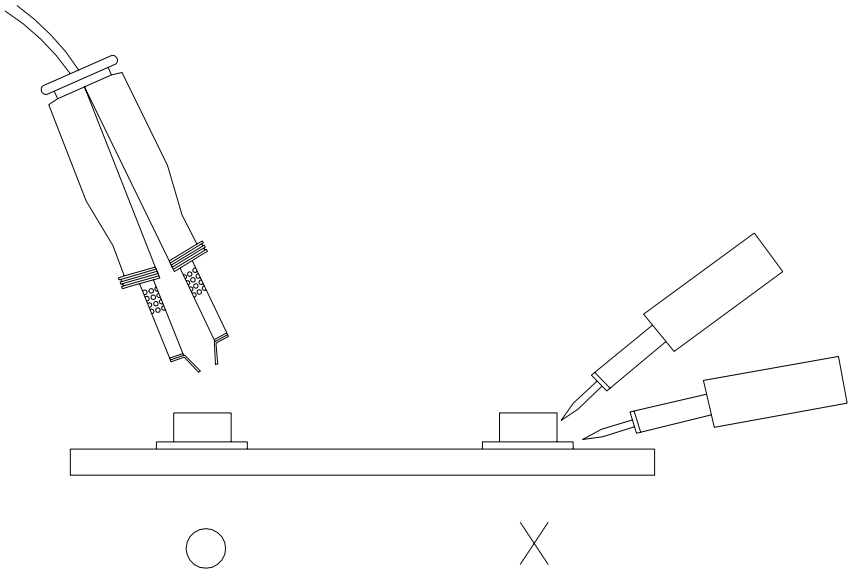
   3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350℃ for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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